

### N-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

#### DESCRIPTION

This product is a switching device which can be driven directly by a 4.5-V power source.

The  $\mu$ PA1803 features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

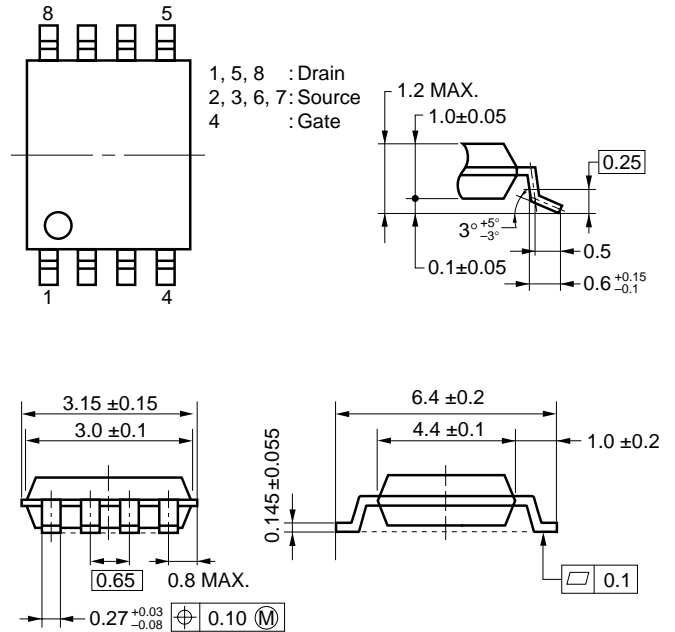
#### FEATURES

- Can be driven by a 4.5-V power source
- Low on-state resistance  
 $R_{DS(on)1} = 12 \text{ m}\Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 4.0 \text{ A)}$   
 $R_{DS(on)2} = 16 \text{ m}\Omega \text{ MAX. (} V_{GS} = 4.5 \text{ V, } I_D = 4.0 \text{ A)}$
- Built-in G-S protection diode against ESD

#### ORDERING INFORMATION

| PART NUMBER        | PACKAGE      |
|--------------------|--------------|
| $\mu$ PA1803GR-9JG | Power TSSOP8 |

#### PACKAGE DRAWING (Unit : mm)



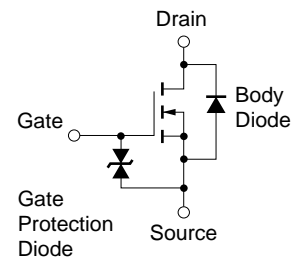
#### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ )

|  |                |             |                  |
|--|----------------|-------------|------------------|
| Drain to Source Voltage                  | $V_{DSS}$      | 30          | V                |
| Gate to Source Voltage                   | $V_{GSS}$      | $\pm 20$    | V                |
| Drain Current (DC)                       | $I_{D(DC)}$    | $\pm 8.0$   | A                |
| Drain Current (pulse) <sup>Note1</sup>   | $I_{D(pulse)}$ | $\pm 32$    | A                |
| Total Power Dissipation <sup>Note2</sup> | $P_T$          | 2.0         | W                |
| Channel Temperature                      | $T_{ch}$       | 150         | $^\circ\text{C}$ |
| Storage Temperature                      | $T_{stg}$      | -55 to +150 | $^\circ\text{C}$ |

- Notes 1.**  $PW \leq 10 \mu\text{s}$ , Duty Cycle  $\leq 1\%$   
**2.** Mounted on ceramic substrate of  $5000 \text{ mm}^2 \times 1.1 \text{ mm}$

**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

#### EQUIVALENT CIRCUIT

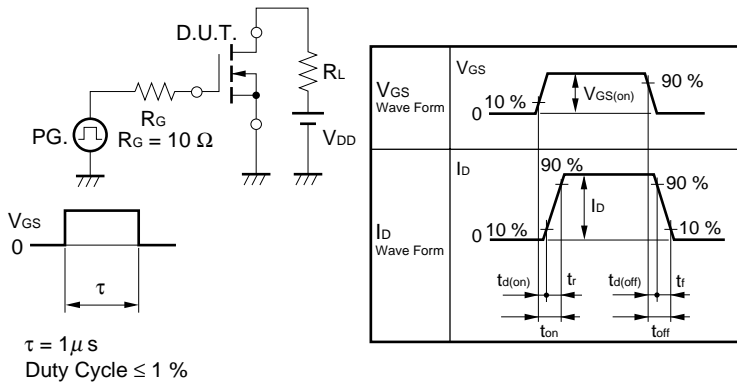


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 Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

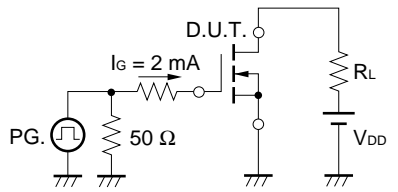
**ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)**

| CHARACTERISTICS                     | SYMBOL               | TEST CONDITIONS                                 | MIN. | TYP. | MAX. | UNIT |
|-------------------------------------|----------------------|---|------|------|------|------|
| Zero Gate Voltage Drain Current     | I <sub>DSS</sub>     | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V   |      |      | 10   | μA   |
| Gate Leakage Current                | I <sub>GSS</sub>     | V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V  |      |      | ±10  | μA   |
| Gate to Source Cut-off Voltage      | V <sub>GS(off)</sub> | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA   | 1.0  | 1.9  | 2.5  | V    |
| Forward Transfer Admittance         | y <sub>fs</sub>      | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 4.0 A  | 3    | 14   |      | S    |
| Drain to Source On-state Resistance | R <sub>DS(on)1</sub> | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4.0 A  |      | 8.6  | 12   | mΩ   |
|                                     | R <sub>DS(on)2</sub> | V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 4.0 A |      | 11   | 16   | mΩ   |
| Input Capacitance                   | C <sub>iss</sub>     | V <sub>DS</sub> = 10 V                          |      | 1880 |      | pF   |
| Output Capacitance                  | C <sub>oss</sub>     | V <sub>GS</sub> = 0 V                           |      | 571  |      | pF   |
| Reverse Transfer Capacitance        | C <sub>rss</sub>     | f = 1 MHz                                       |      | 214  |      | pF   |
| Turn-on Delay Time                  | t <sub>d(on)</sub>   | V <sub>DD</sub> = 15 V                          |      | 27   |      | ns   |
| Rise Time                           | t <sub>r</sub>       | I <sub>D</sub> = 4.0 A                          |      | 77   |      | ns   |
| Turn-off Delay Time                 | t <sub>d(off)</sub>  | V <sub>GS(on)</sub> = 10 V                      |      | 72   |      | ns   |
| Fall Time                           | t <sub>f</sub>       | R <sub>G</sub> = 10 Ω                           |      | 47   |      | ns   |
| Total Gate Charge                   | Q <sub>G</sub>       | V <sub>DS</sub> = 24 V                          |      | 36   |      | nC   |
| Gate to Source Charge               | Q <sub>GS</sub>      | I <sub>D</sub> = 8.0 A                          |      | 5.1  |      | nC   |
| Gate to Drain Charge                | Q <sub>GD</sub>      | V <sub>GS</sub> = 10 V                          |      | 8.7  |      | nC   |
| Diode Forward Voltage               | V <sub>F(S-D)</sub>  | I <sub>F</sub> = 8.0 A, V <sub>GS</sub> = 0 V   |      | 0.78 |      | V    |
| Reverse Recovery Time               | t <sub>rr</sub>      | I <sub>F</sub> = 8.0 A, V <sub>GS</sub> = 0 V   |      | 37   |      | ns   |
| Reverse Recovery Charge             | Q <sub>rr</sub>      | di/dt = 100 A/μs                                |      | 35   |      | nC   |

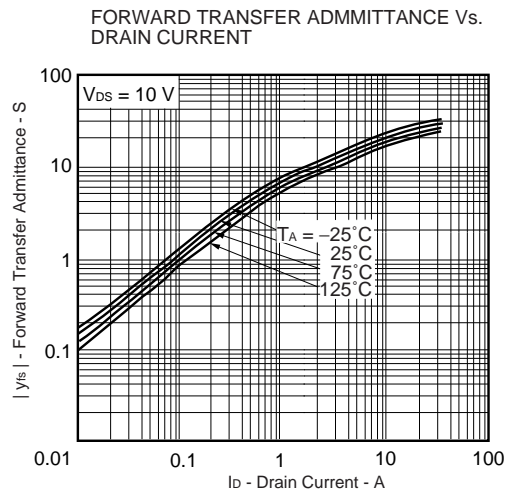
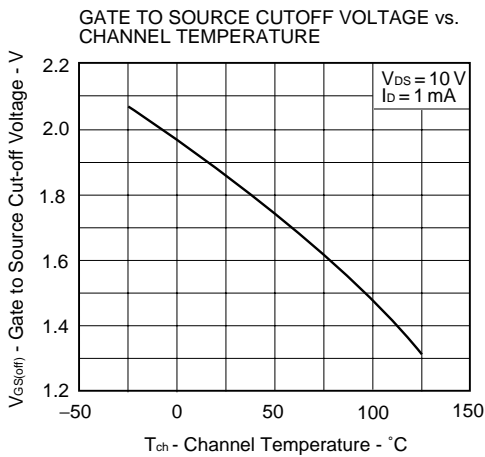
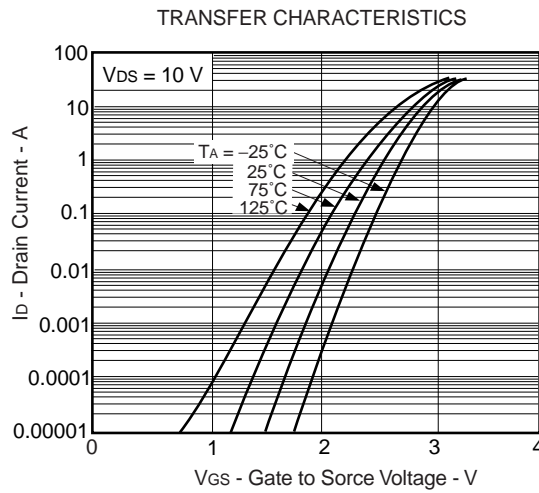
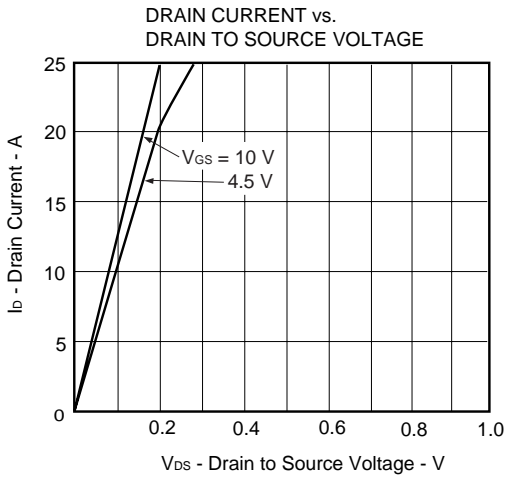
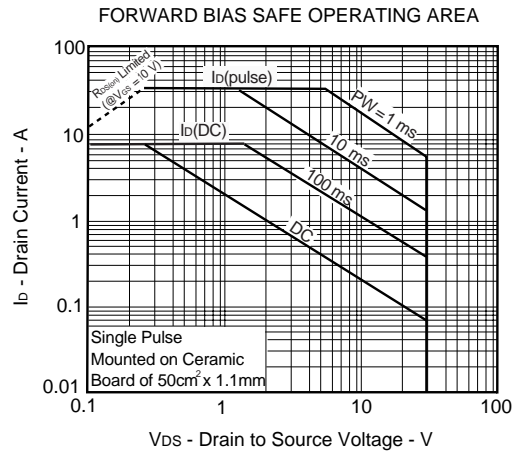
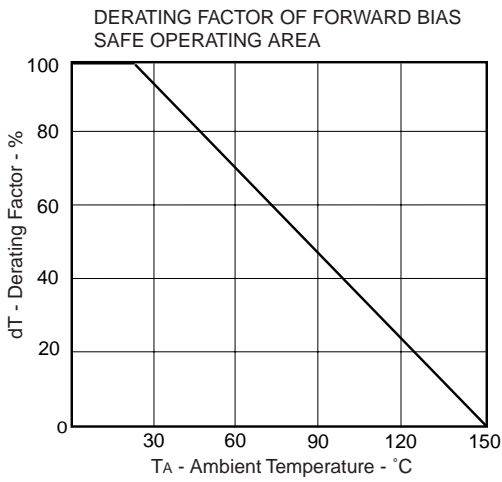
**TEST CIRCUIT 1 SWITCHING TIME**

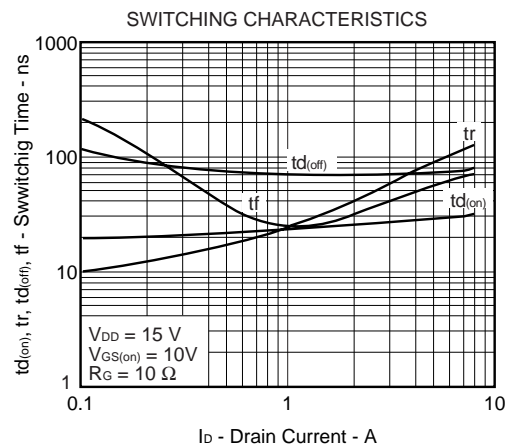
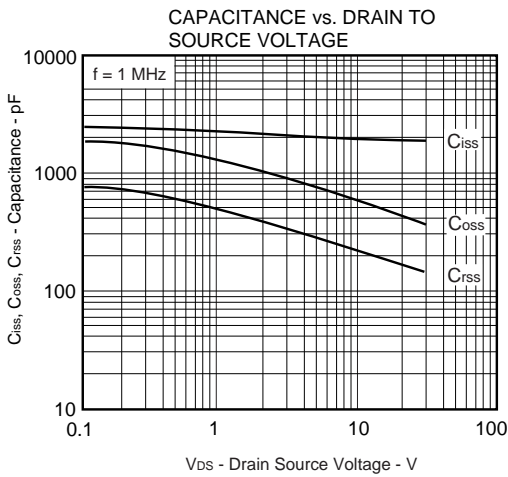
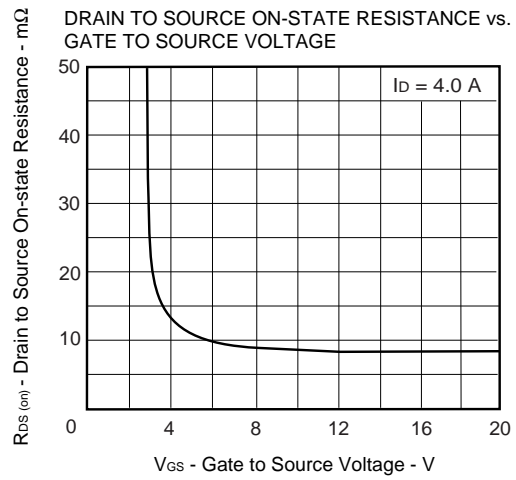
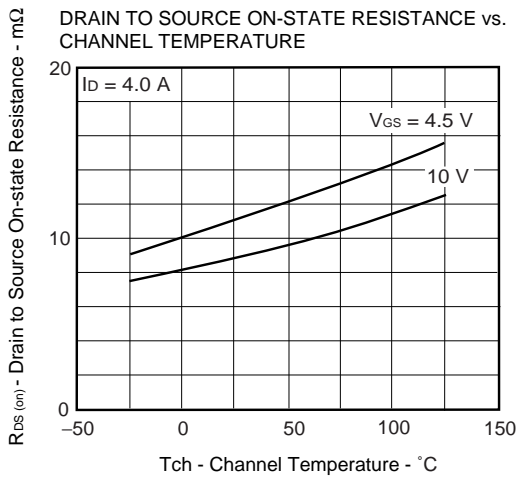
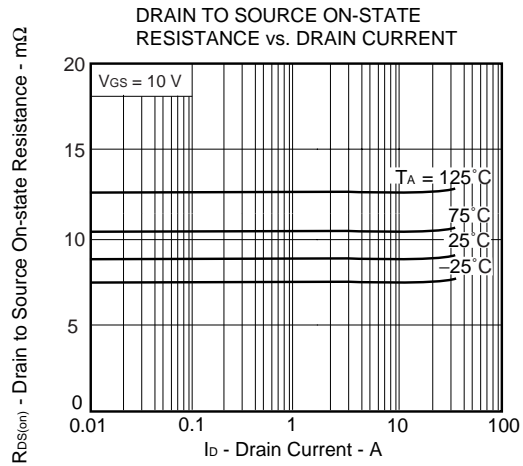
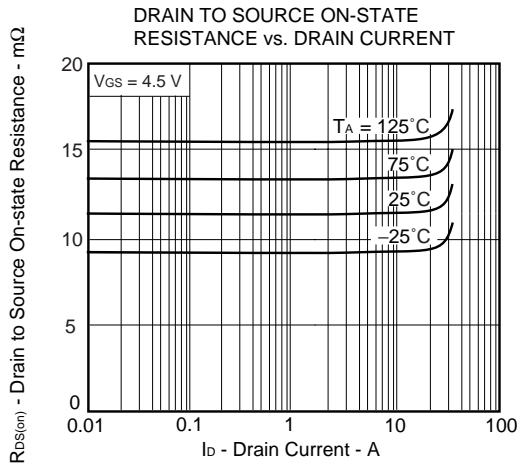


**TEST CIRCUIT 2 GATE CHARGE**

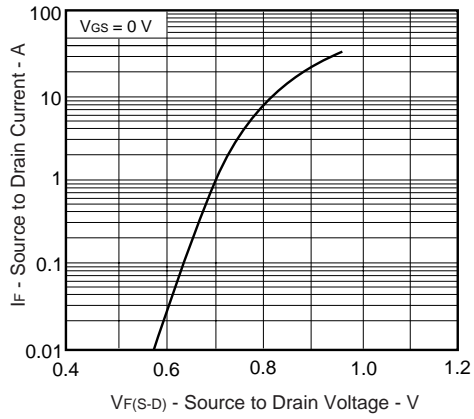


★ TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)

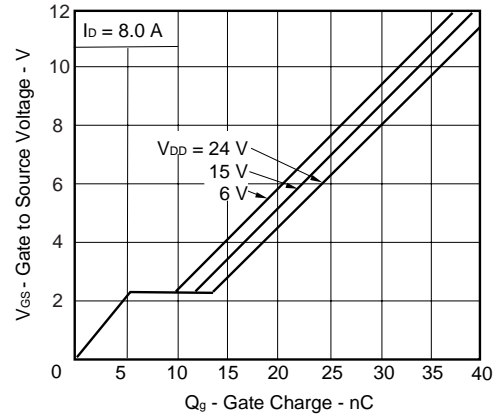




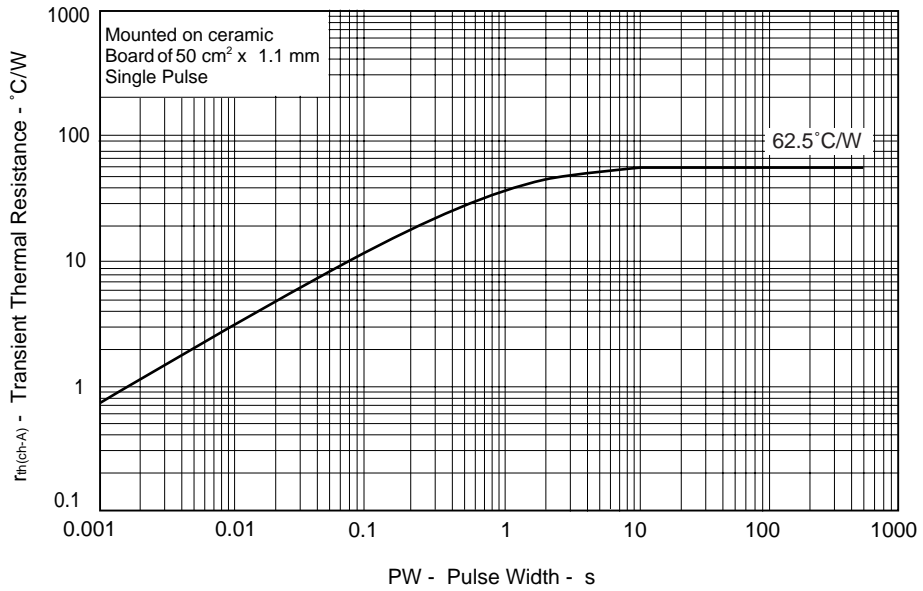
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



DYNAMIC INPUT CHARACTERISTICS



TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



[MEMO]

[MEMO]

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